



DMTH3002LPS

PowerDI

Product Summary

BV _{DSS}	R _{DS(ON)}	Ι _D T _C = +25°C
30V	$1.6m\Omega @ V_{GS} = 10V$	100A

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize R_{DS(ON)}, yet maintain superior switching performance. This device is ideal for use in power management and load switch.

Applications

- **DC-DC** Converters
- Load Switch

Features

Thermally Efficient Package - Cooler Running Applications •

30V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET

- <1.1mm Package Profile Ideal for Thin Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

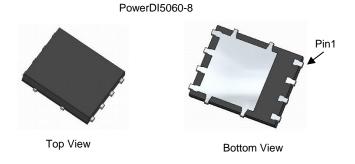
- Case: PowerDl[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below

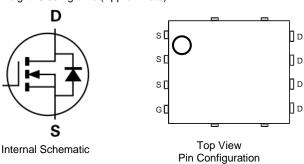
⊃¦¦ = Manufacturer's Marking H3002LS = Product Type Marking Code

YYWW = Date Code Marking

YY = Year (ex: 16 = 2016)WW = Week (01 to 53)

- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)





Ordering Information (Note 4)

Part Number	Case	Packaging			
DMTH3002LPS-13	PowerDI5060-8	2,500/Tape & Reel			
DIVITIO002EI 0 13	T OWCIDISOOD 0	2,300/ Tape & Neel			

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied. Notes:

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

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3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



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Maximum Ratings (@T_c = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	V _{GSS}	±16	V		
Continuous Drain Current, V _{GS} = 10V (Note 7)	ID	100 100	А		
Maximum Continuous Body Diode Forward Current (N	Is	100	A		
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)	I _{DM}	150	А		
Avalanche Current, L=3mH (Note 8)			I _{AS}	15	A
Avalanche Energy, L=3mH (Note 8)			E _{AS}	700	mJ

Thermal Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	103	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	51	°C/W
Total Power Dissipation (Note 7)	T _C = +25°C	PD	136	W
Thermal Resistance, Junction to Case (Note 7)		R _{θJC}	1.1	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

		-					
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	IDSS		—	1	μA	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	1	—	2	V	$V_{DS} = V_{GS}, I_D = 1mA$	
Static Drain-Source On-Resistance			1.25	1.6	mΩ	$V_{GS} = 10V, I_D = 25A$	
	R _{DS(ON)}		2	2.5	11152	$V_{GS} = 4.5V, I_D = 25A$	
Diode Forward Voltage	V _{SD}		0.8	1.1	V	$V_{GS} = 0V, I_{S} = 25A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C _{ISS}		5,000	—		V _{DS} = 15V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss		2,660	_	pF		
Reverse Transfer Capacitance	C _{RSS}	_	300	_			
Gate Resistance	R _G	_	0.75	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge ($V_{GS} = 4.5V$)	Q _G		37	—			
Total Gate Charge (V _{GS} = 10V)	Q _G	_	77	_	nC	V _{DS} = 15V, I _D = 25A	
Gate-Source Charge	Q _{GS}	_	10	_	nc		
Gate-Drain Charge	Q _{GD}	_	14	_			
Turn-On Delay Time	t _{D(ON)}	_	21	_			
Turn-On Rise Time	t _R	_	45	_		$V_{DD} = 15V, V_{GS} = 4.5V,$ $I_D = 25A, R_G = 4.7\Omega$	
Turn-Off Delay Time	t _{D(OFF)}	_	32	_	ns		
Turn-Off Fall Time	t _F		26	_			
Body Diode Reverse Recovery Time	t _{RR}		44	_	ns		
Body Diode Reverse Recovery Charge	Q _{RR}	_	52	—	nC	$I_{\rm S} = 15$ A, di/dt = 100A/µs	

Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

7. Thermal resistance from junction to soldering point (on the exposed drain pad).

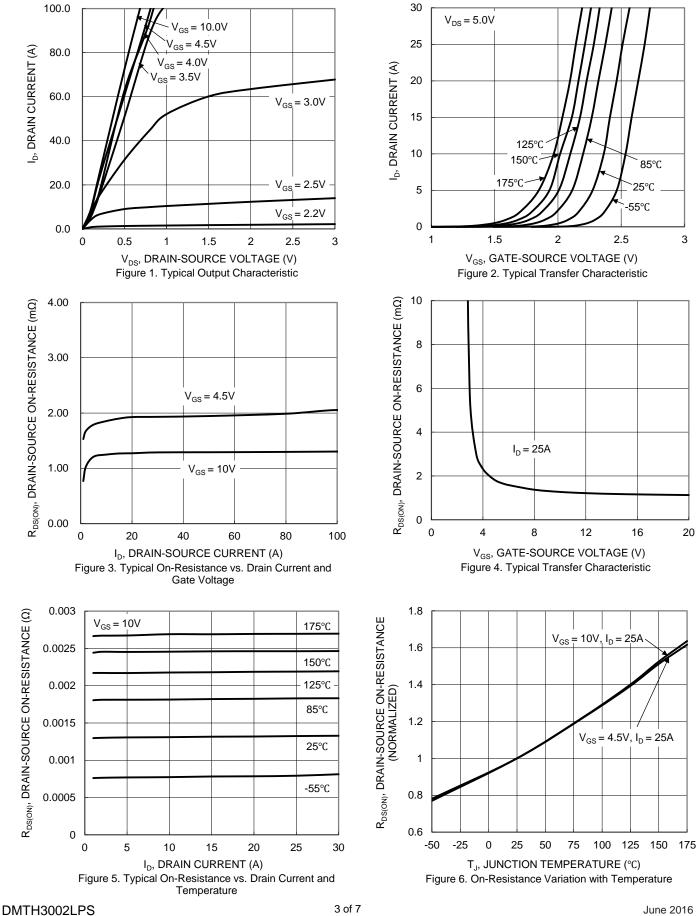
8. IAS and EAS rating are based on low frequency and duty cycles to keep T_J = +25°C.

9. Short duration pulse test used to minimize self-heating effect.

10. Guaranteed by design. Not subject to product testing.



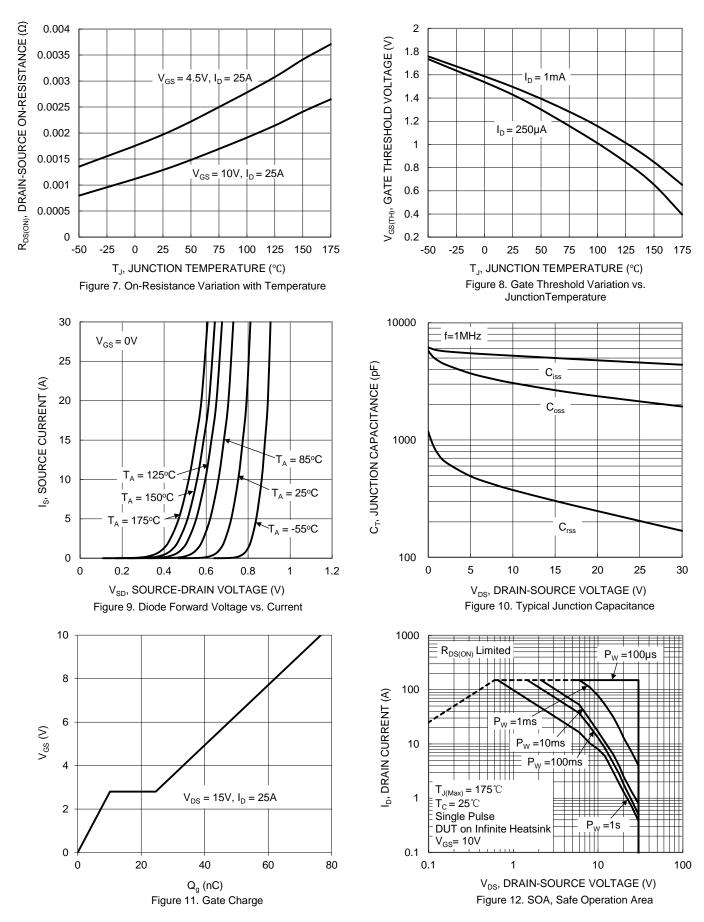
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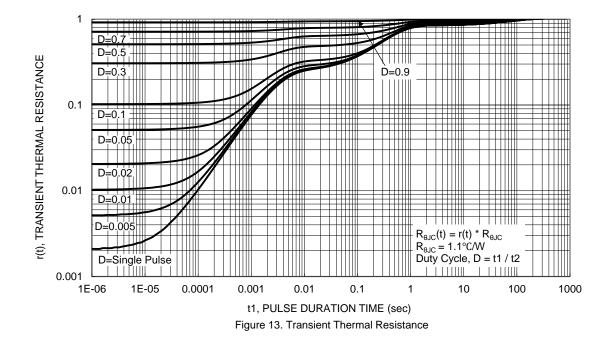


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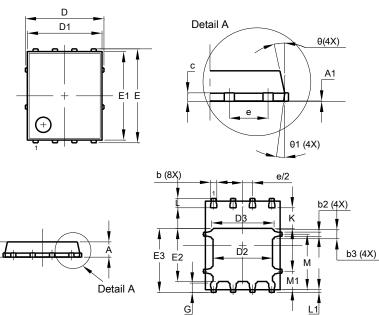






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

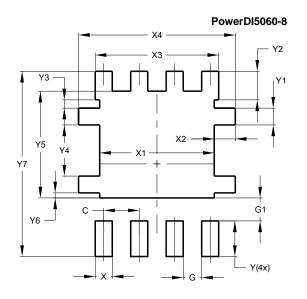


PowerDI5060-8

PowerDI5060-8						
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0.00	-				
b	0.33	0.51	0.41			
b2	0.200	0.350	0.273			
b3	0.40	0.80	0.60			
C	0.230	0.330	0.277			
D		5.15 BSC				
D1	4.70	5.10	4.90			
D2	3.70	3.90				
D3	3.90	4.10				
ш	(6.15 BSC				
E1	5.60	6.00	5.80			
E2	3.28	3.68	3.48			
E3	3.99 4.39 4.1					
e		1.27 BSC				
G	0.51	0.71	0.61			
ĸ	0.51	-	-			
L	0.51 0.71 0.61					
L1	0.100 0.200 0.1					
М	3.235 4.035 3.6					
M1	1.00	1.40	1.21			
Θ	10°	12°	11°			
Θ1	6°	8°	7°			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

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